Vincotech

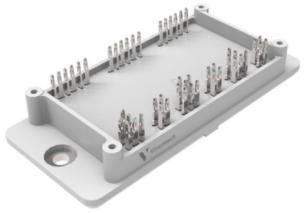
30-P2126PA050SC-L287F09Y
datasheet

***flow* PACK 2** **1200 V / 50 A**

Features

- IGBT4 (1200 V) technology for low saturation losses and improved EMC behavior
- Compact and low inductive design
- Integrated temperature sensor

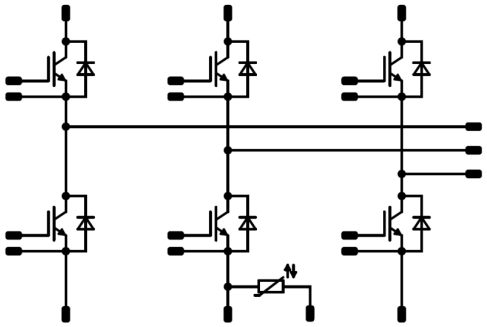
flow 2 17 mm housing



Target applications

- Industrial drives

Schematic



Types

- 30-P2126PA050SC-L287F09Y

Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	T_j = T_{jmax} T_s = 80 °C	65	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	T_j = T_{jmax} T_s = 80 °C	185	W
Gate-emitter voltage	V_{GES}		±20	V
Short circuit ratings	t_{SC} V_{CC}	T_j ≤ 150 °C V_{GE} = 15 V	10 800	µs V
Maximum Junction Temperature	T_{jmax}		175	°C

Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	T_j = T_{jmax} T_s = 80°C	65	A
Repetitive peak forward current	I_{FRM}		100	A
Total power dissipation	P_{tot}	T_j = T_{jmax} T_s = 80°C	127	W
Maximum Junction Temperature	T_{jmax}		175	°C
Module Properties				
Thermal Properties				
Storage temperature	T_{stg}		-40…+125	°C
Operation temperature under switching condition	T_{jop}		-40…(T_{jmax} - 25)	°C
Isolation Properties				
Isolation voltage	V_{isol}	DC Test Voltage* t_p = 2 s	4000	V
		AC Voltage t_p = 1 min	2500	V
Creepage distance			min. 12,7	mm
Clearance			min. 12,7	mm
Comparative Tracking Index	CTI		> 200	

*100 % tested in production

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Inverter Switch										
Static										
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0017	25 125	5,3	5,8	6,3	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	25 150	1,58	1,88 2,30	2,07	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			1	µA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							4		Ω
Input capacitance	C_{ies}	f= 1 MHz	0	25		25		2800		pF
Reverse transfer capacitance	C_{res}							100		
Thermal										
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material λ = 3,4 W/mK						0,51		K/W
IGBT Switching										
Turn-on delay time	$t_{d(on)}$	R_{goff} = 8 Ω R_{gon} = 8 Ω	±15	600	50	25 150		96 101		ns
Rise time	t_r					25 150		17 24		
Turn-off delay time	$t_{d(off)}$					25 150		214 281		
Fall time	t_f					25 150		87 122		
Turn-on energy (per pulse)	E_{on}	Q_{rFWD} = 4,8 µC Q_{rFWD} = 9,7 µC				25 150		2,701 4,211		mWs
Turn-off energy (per pulse)	E_{off}					25 150		2,744 4,531		

Characteristic Values

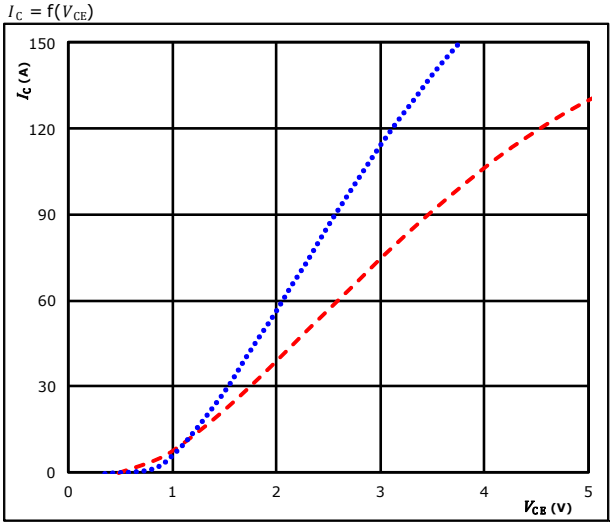
Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Inverter Diode										
Static										
Forward voltage	V_F				50	25 125 150		1,73 1,70 1,68	2,05	V
Reverse leakage current	I_r			1200		25			10	µA
Thermal										
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material λ = 3,4 W/mK						0,75		K/W
FWD Switching										
Peak recovery current	I_{RRM}	di/dt = 3866 A/µs di/dt = 2820 A/µs	±15	600	50	25 150		81 85		A
Reverse recovery time	t_{rr}					25 150		139 316		ns
Recovered charge	Q_r					25 150		4,797 9,708		µC
Reverse recovered energy	E_{rec}					25 150		1,790 3,972		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 150		4803 1209		A/µs
Thermistor										
Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	R_{100} = 1486 Ω				100	-12		+14	%
Power dissipation	P					25		200		mW
Power dissipation constant						25		2		mW/K
B-value	$B_{(25/50)}$	Tol. ±3%				25		3950		K
B-value	$B_{(25/100)}$	Tol. ±3%				25		3998		K
Vincotech NTC Reference									B	

Inverter Switch Characteristics

figure 1. **IGBT**

Typical output characteristics

$I_C = f(V_{CE})$

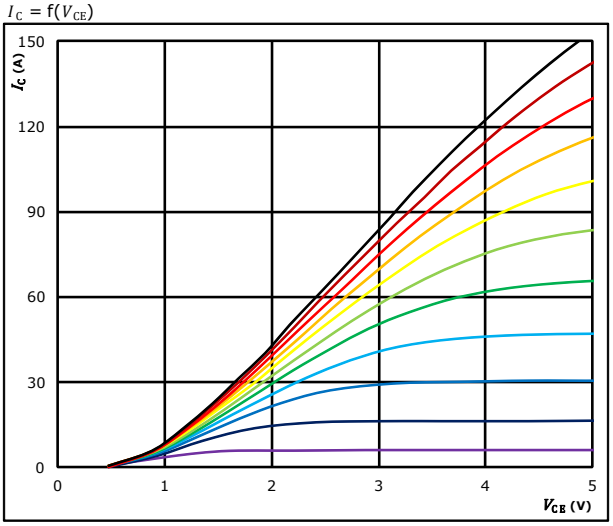


t_p =	250	µs		25 °C	
V_{GE} =	15	V	T_j:	150 °C	

figure 2. **IGBT**

Typical output characteristics

$I_C = f(V_{CE})$

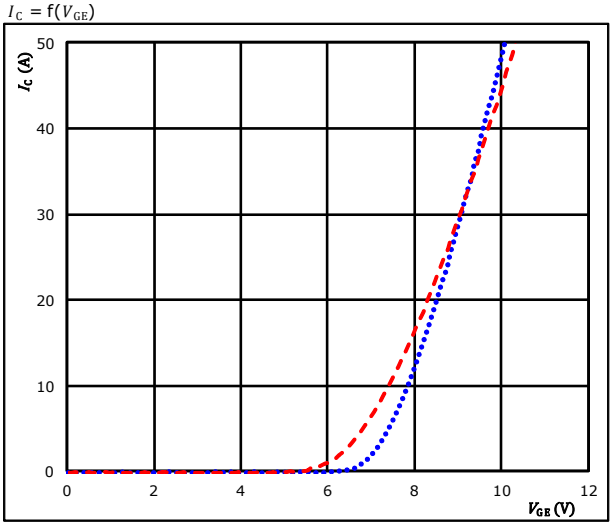


t_p =	250	µs
T_j =	150	°C
V_{GE} from	7 V to 17 V in steps of 1 V	

figure 3. **IGBT**

Typical transfer characteristics

$I_C = f(V_{GE})$

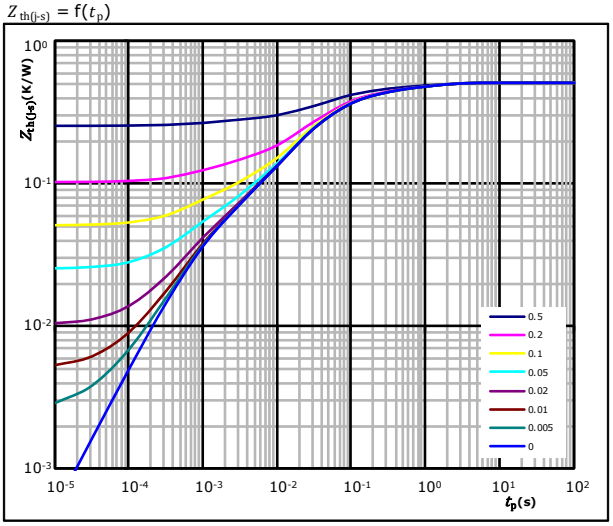


t_p =	100	µs		25 °C	
V_{CE} =	10	V	T_j:	150 °C	

figure 4. **IGBT**

Transient Thermal Impedance as function of Pulse duration

$Z_{th(j-s)} = f(t_p)$



D =	t_p / T	
$R_{th(j-s)}$ =	0,51	K/W

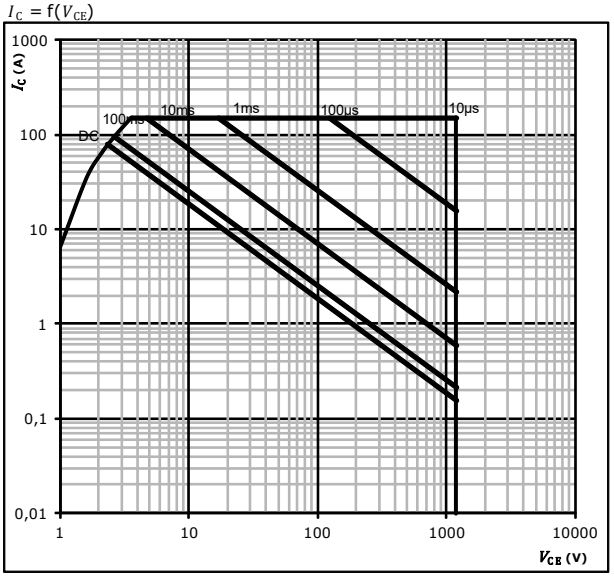
IGBT thermal model values

R (K/W)	τ (s)
7,12E-02	1,13E+00
1,15E-01	1,65E-01
2,22E-01	3,78E-02
6,59E-02	1,21E-02
3,86E-02	9,52E-04

Inverter Switch Characteristics

Safe operating area **IGBT**

$I_C = f(V_{CE})$



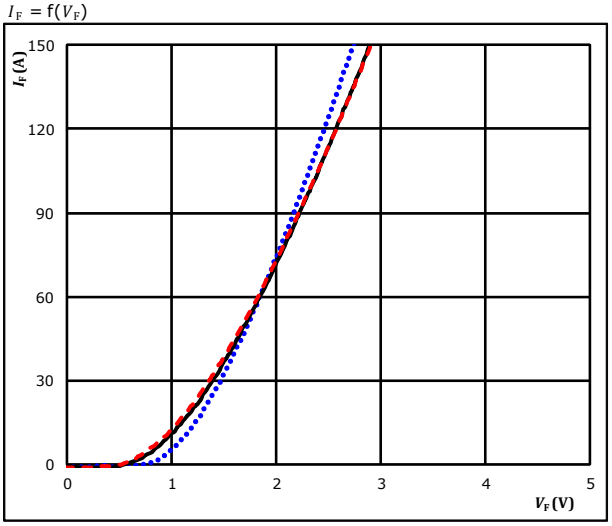
At

D =	single pulse	
T_s =	80	ºC
V_{GE} =	±15	V
T_j =	T_{jmax}	

Inverter Diode Characteristics

Typical forward characteristics **FWD**

$I_F = f(V_F)$

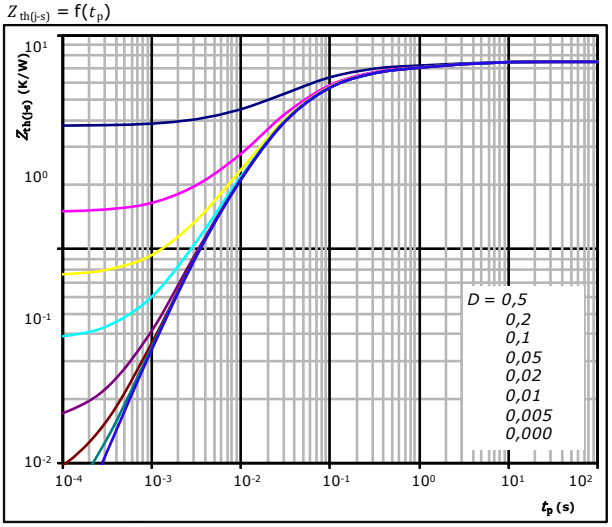


t_p = 250 µs

T_j: 25 °C, 125 °C, 150 °C

Transient thermal impedance as a function of pulse width **FWD**

$Z_{th(j-s)} = f(t_p)$



D = t_p / T

$R_{th(j-s)}$ = 0,75 K/W

FWD thermal model values

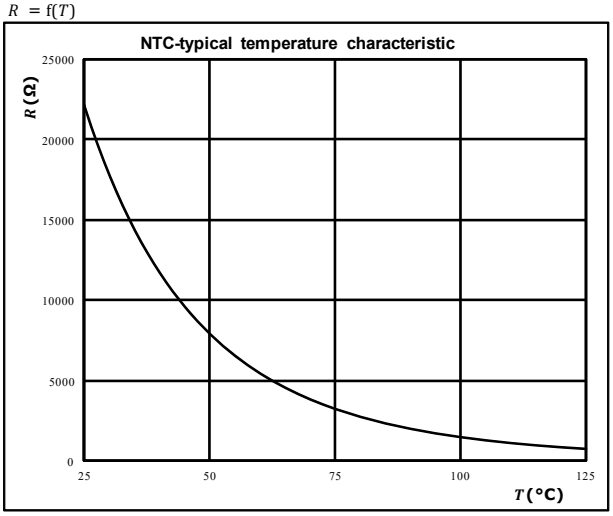
R (K/W)	τ (s)
4,26E-02	3,64E+00
6,76E-02	6,18E-01
2,53E-01	8,65E-02
3,23E-01	2,11E-02
6,24E-02	3,47E-03

Thermistor Characteristics

figure 1. **Thermistor**

Typical NTC characteristic as a function of temperature

$R = f(T)$

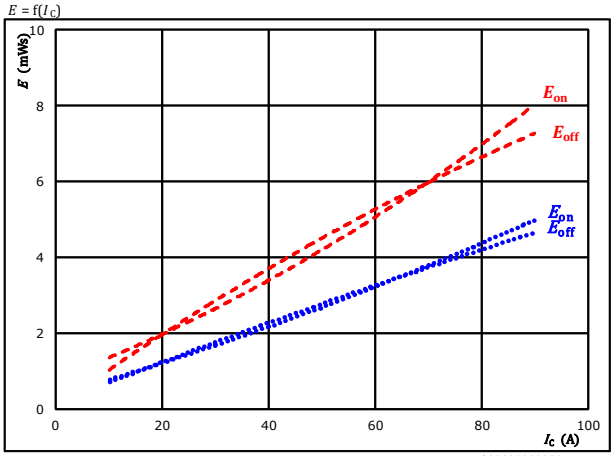


Inverter Switching Definitions

Figure 1. **IGBT**

Typical switching energy losses as a function of collector current

$E = f(I_C)$



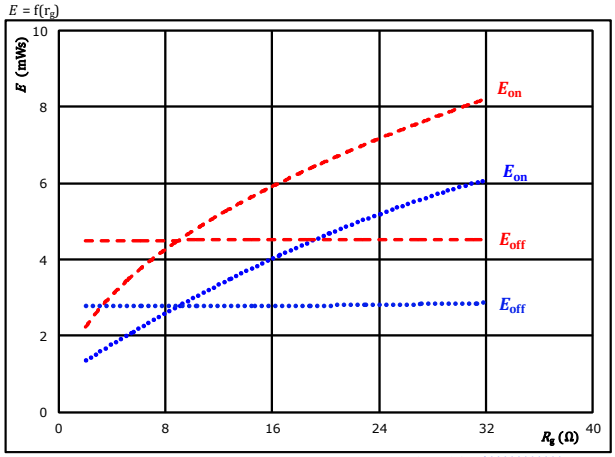
With an inductive load at
25 °C
T_j:
150 °C

V_{CE} =	600	V
V_{GE} =	±15	V
R_{gon} =	8	Ω
R_{goff} =	8	Ω

Figure 2. **IGBT**

Typical switching energy losses as a function of gate resistor

$E = f(r_G)$



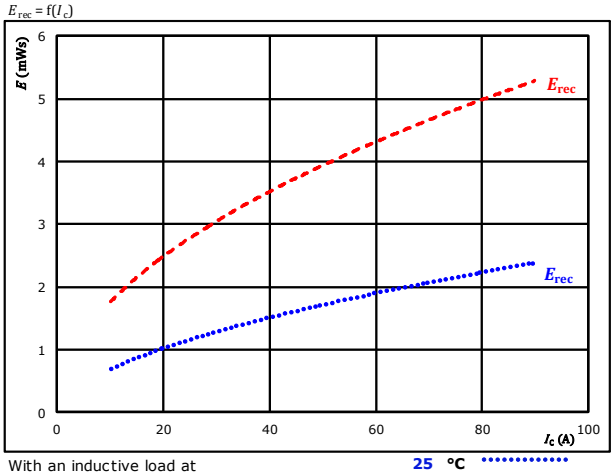
With an inductive load at
25 °C
T_j:
150 °C

V_{CE} =	600	V
V_{GE} =	±15	V
I_C =	50	A

Figure 3. **FWD**

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_C)$



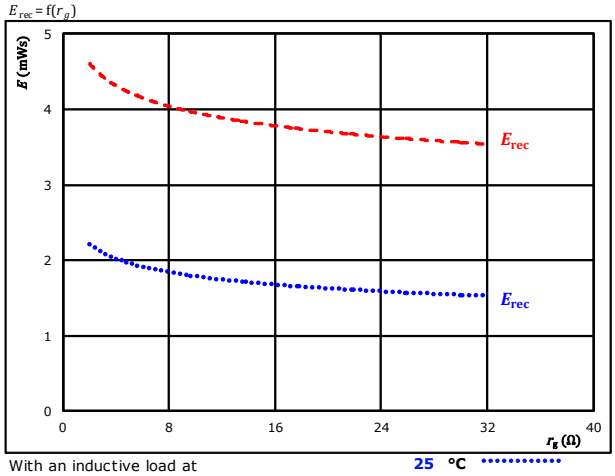
With an inductive load at
25 °C
T_j:
150 °C

V_{CE} =	600	V
V_{GE} =	±15	V
R_{gon} =	8	Ω

Figure 4. **FWD**

Typical reverse recovered energy loss as a function of gate resistor

$E_{rec} = f(r_g)$



With an inductive load at
25 °C
T_j:
150 °C

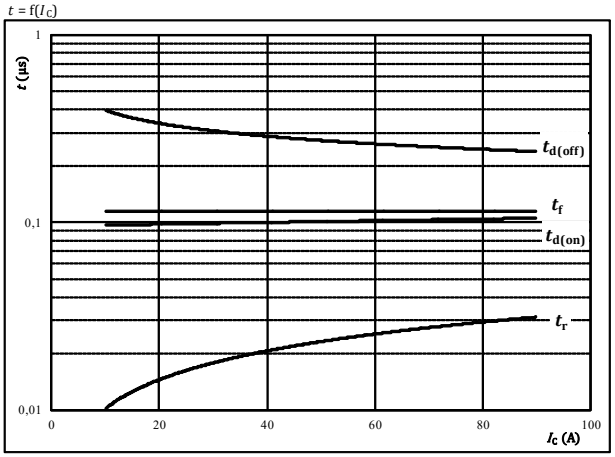
V_{CE} =	600	V
V_{GE} =	±15	V
I_C =	50	A

Inverter Switching Definitions

Figure 5. **IGBT**

Typical switching times as a function of collector current

$t = f(I_C)$



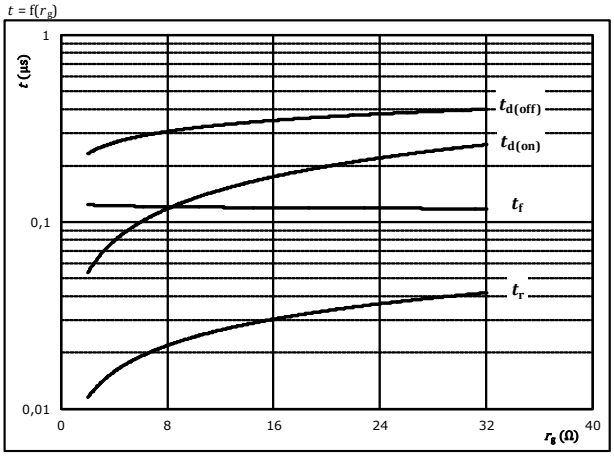
With an inductive load at

T_j =	150	°C
V_{CE} =	600	V
V_{GE} =	±15	V
R_{gon} =	8	Ω
R_{goff} =	8	Ω

Figure 6. **IGBT**

Typical switching times as a function of gate resistor

$t = f(r_g)$



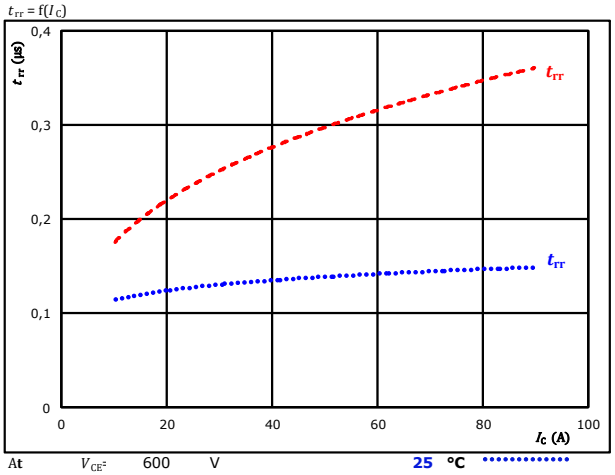
With an inductive load at

T_j =	150	°C
V_{CE} =	600	V
V_{GE} =	±15	V
I_C =	50	A

Figure 7. **FWD**

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$

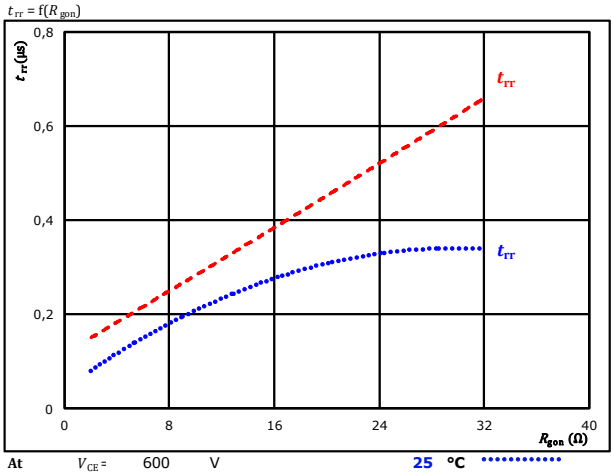


At	V_{CE} =	600	V		25 °C
	V_{GE} =	±15	V	T_j:	150 °C
	R_{gon} =	8	Ω		

Figure 8. **FWD**

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



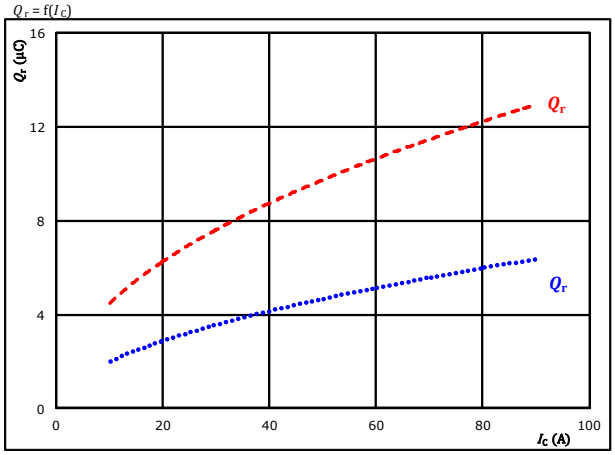
At	V_{CE} =	600	V		25 °C
	V_{GE} =	±15	V	T_j:	150 °C
	I_C =	50	A		

Inverter Switching Definitions

Figure 9. **FWD**

Typical recovered charge as a function of collector current

$Q_r = f(I_C)$

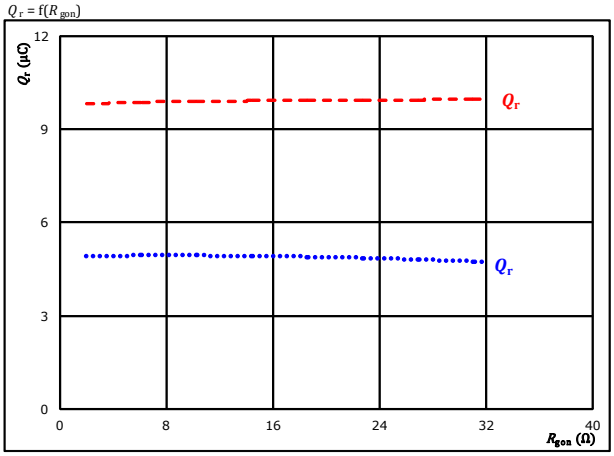


At	V_{CE} =	600	V		25 °C	
	V_{GE} =	±15	V	T_j:	150 °C	
	R_{gon} =	8	Ω			

Figure 10. **FWD**

Typical recoved charge as a function of IGBT turn on gate resistor

$Q_r = f(R_{gon})$

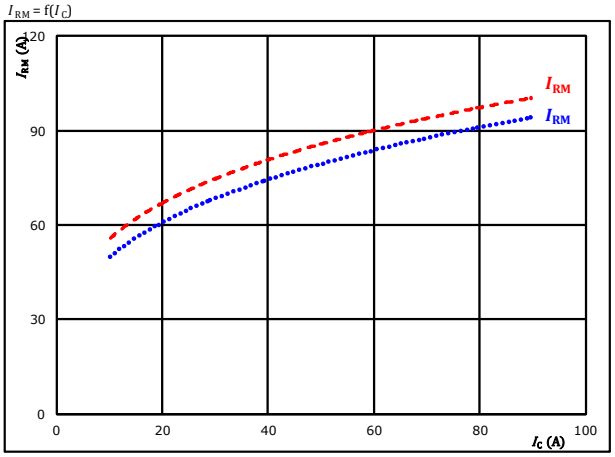


At	V_{CE} =	600	V		25 °C	
	V_{GE} =	±15	V	T_j:	150 °C	
	I_C =	50	A			

Figure 11. **FWD**

Typical peak reverse recovery current current as a function of collector current

$I_{RM} = f(I_C)$

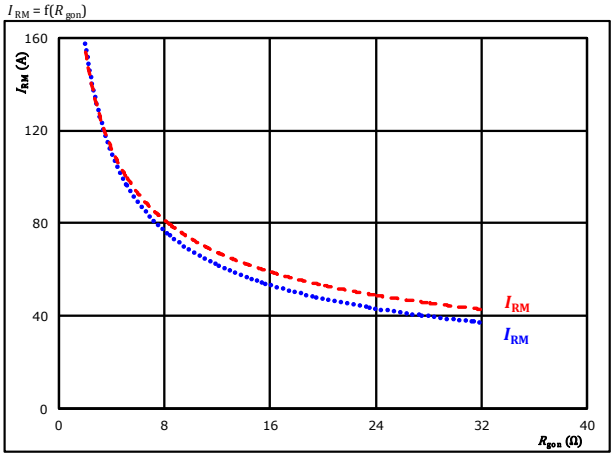


At	V_{CE} =	600	V		25 °C	
	V_{GE} =	±15	V	T_j:	150 °C	
	R_{gon} =	8	Ω			

Figure 12. **FWD**

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$I_{RM} = f(R_{gon})$



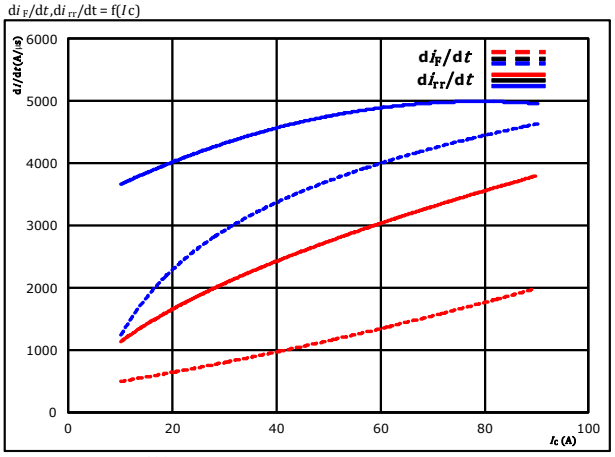
At	V_{CE} =	600	V		25 °C	
	V_{GE} =	±15	V	T_j:	150 °C	
	I_C =	50	A			

Inverter Switching Definitions

Figure 13. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$

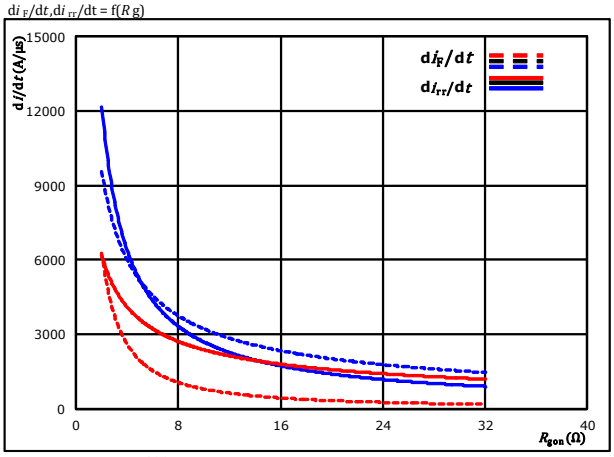


At					
V_{CE} =	600	V		25 °C	
V_{GE} =	±15	V	T_j:	150 °C	
R_{gon} =	8	Ω			

Figure 14. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_g)$

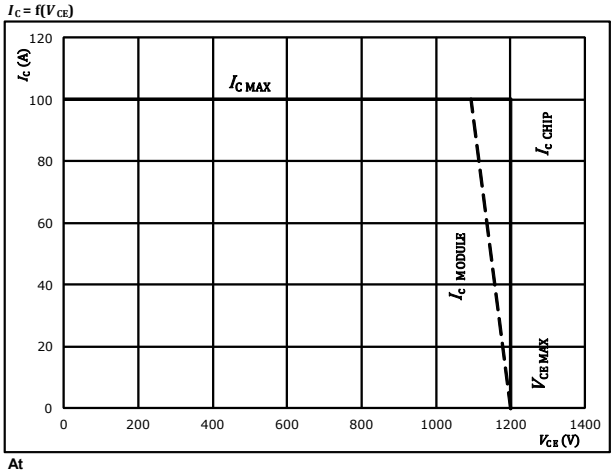


At					
V_{CE} =	600	V		25 °C	
V_{GE} =	±15	V	T_j:	150 °C	
I_C =	50	A			

Figure 15. **IGBT**

Reverse bias safe operating area

$I_C = f(V_{CE})$



At

T_j =	175	°C
R_{gon} =	8	Ω
R_{goff} =	8	Ω

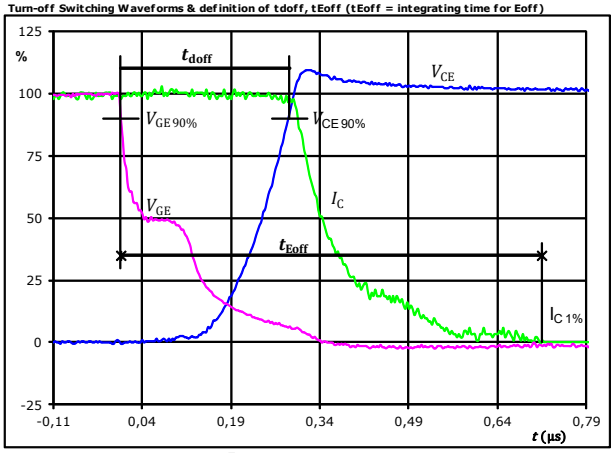
Inverter Switching Characteristics

General conditions

T_j	=	150 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

Figure 1. IGBT

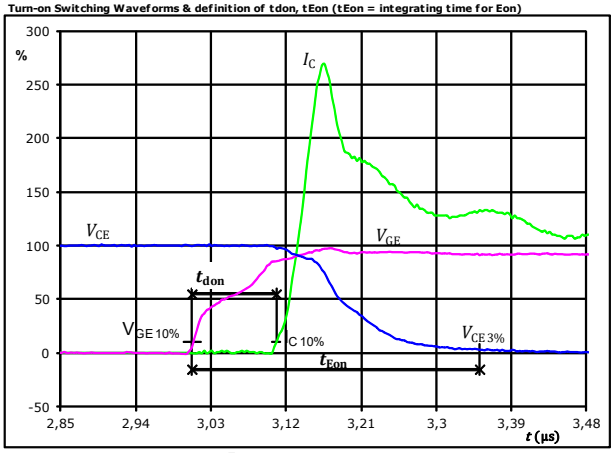
Turn-off Switching Waveforms & definition of tdoff, tEoff (tEoff = integrating time for Eoff)



$V_{GE}(0\%)$ =	-15	V
$V_{GE}(100\%)$ =	15	V
$V_C(100\%)$ =	600	V
$I_C(100\%)$ =	50	A
t_{doff} =	0,281	µs
t_{Eoff} =	0,710	µs

Figure 2. IGBT

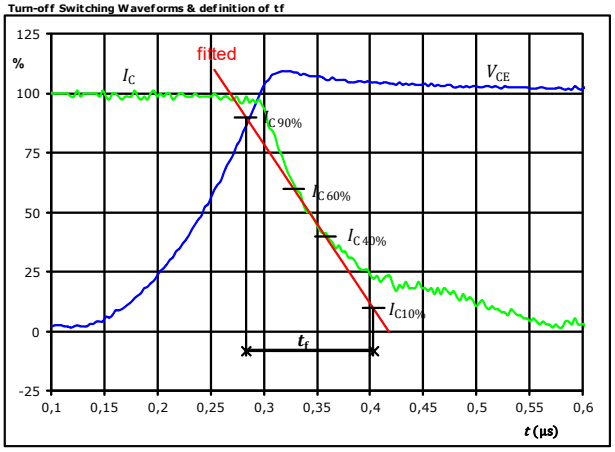
Turn-on Switching Waveforms & definition of tdon, tEon (tEon = integrating time for Eon)



$V_{GE}(0\%)$ =	-15	V
$V_{GE}(100\%)$ =	15	V
$V_C(100\%)$ =	600	V
$I_C(100\%)$ =	50	A
t_{don} =	0,101	µs
t_{Eon} =	0,345	µs

Figure 3. IGBT

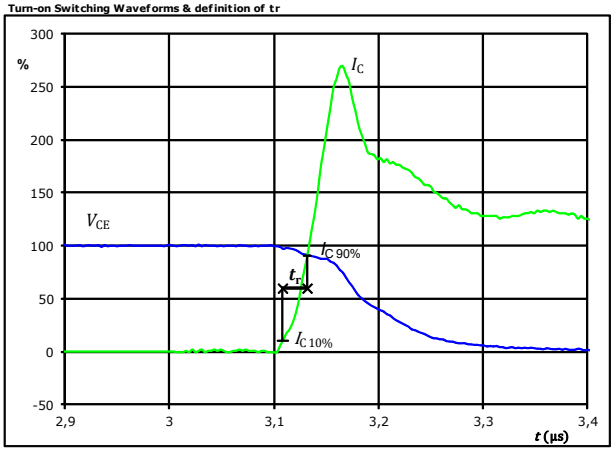
Turn-off Switching Waveforms & definition of tf



$V_C(100\%)$ =	600	V
$I_C(100\%)$ =	50	A
t_f =	0,122	µs

Figure 4. IGBT

Turn-on Switching Waveforms & definition of tr

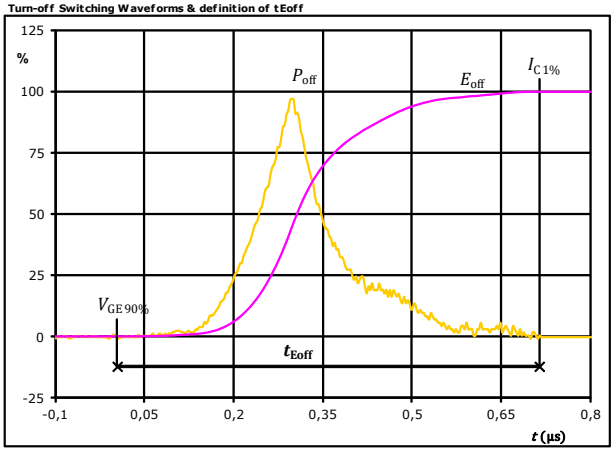


$V_C(100\%)$ =	600	V
$I_C(100\%)$ =	50	A
t_r =	0,024	µs

Inverter Switching Characteristics

Figure 5. **IGBT**

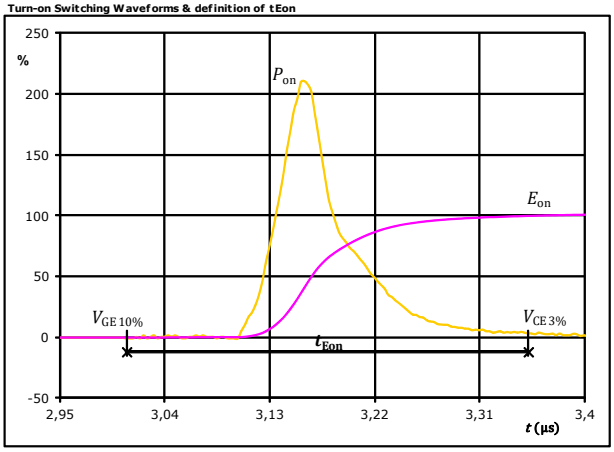
Turn-off Switching Waveforms & definition of tEoff



$P_{off}(100\%)$ =	30,10	kW
$E_{off}(100\%)$ =	4,53	mJ
t_{Eoff} =	0,71	µs

Figure 6. **IGBT**

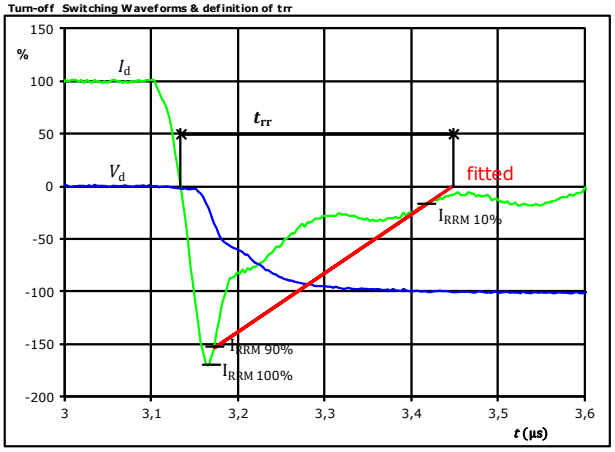
Turn-on Switching Waveforms & definition of tEon



$P_{on}(100\%)$ =	30,10	kW
$E_{on}(100\%)$ =	4,21	mJ
t_{Eon} =	0,345	µs

Figure 7. **FWD**

Turn-off Switching Waveforms & definition of trr

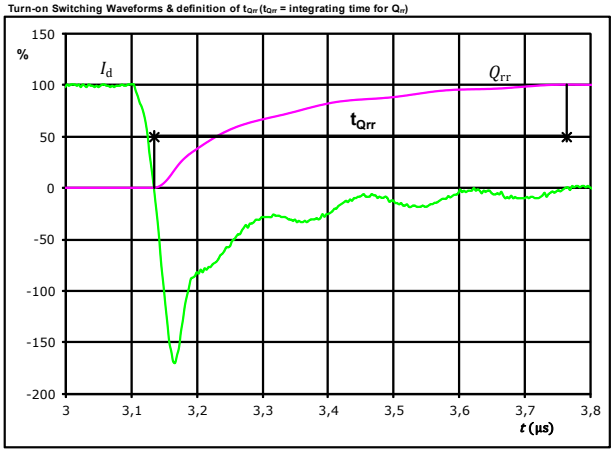


$V_d(100\%)$ =	600	V
$I_d(100\%)$ =	50	A
$I_{RRM}(100\%)$ =	-85	A
t_{rr} =	0,316	µs

Inverter Switching Characteristics

Figure 8. **FWD**

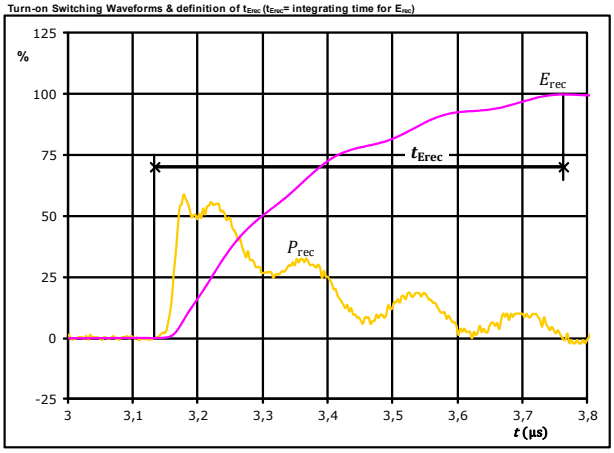
Turn-on Switching Waveforms & definition of t_{Qrr} (t_{Qrr} = integrating time for Q_{rr})



I_d (100%) =	50	A
Q_{rr} (100%) =	9,71	µC
t_{Qrr} =	0,63	µs

Figure 9. **FWD**

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec}= integrating time for E_{rec})



P_{rec} (100%) =	30,10	kW
E_{rec} (100%) =	3,97	mJ
t_{Erec} =	0,63	µs

Ordering Code & Marking

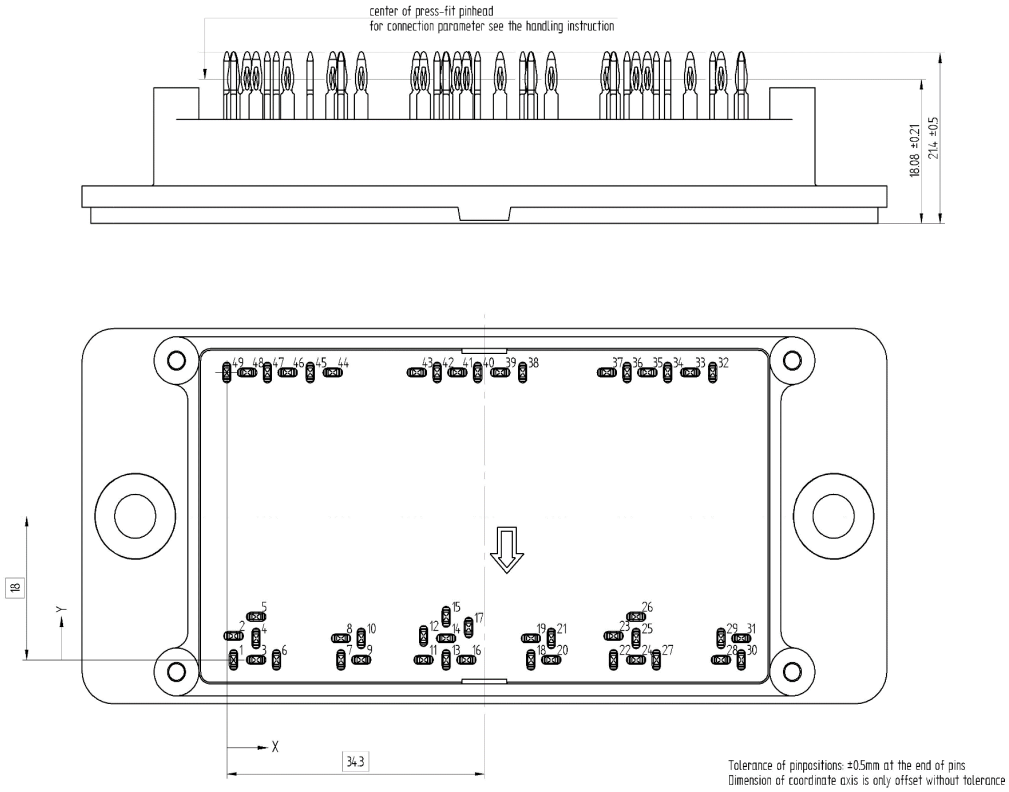
Version	Ordering Code
without thermal paste 17 mm housing	30-P2126PA050SC-L287F09Y

	Name		Date code	UL & VIN	Lot	Serial
Text	N-NNNNNNNNNNNNN-TTTTTTV		WWYY	UL VIN	LLLLL	SSSS
Datamatrix	**Type&Ver**	**Lot number**	**Serial**	**Date code**		
	TTTTTTVV	LLLLL	SSSS	WWYY		

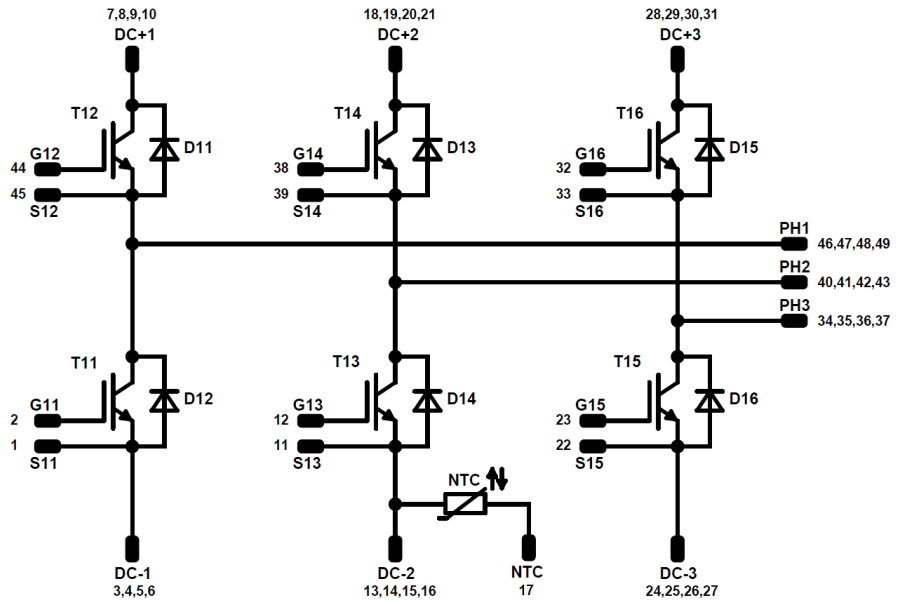
Outline

Pin table [mm]

Pin	X	Y	Function
1	0,9	0	S11
2	0,9	3	G11
3	3,9	0	DC-1
4	3,9	2,7	DC-1
5	3,9	5,4	DC-1
6	6,6	0	DC-1
7	15,2	0	DC+1
8	15,2	2,7	DC+1
9	17,9	0	DC+1
10	17,9	2,7	DC+1
11	26,2	0	S13
12	26,2	3	G13
13	29,2	0	DC-2
14	29,2	2,7	DC-2
15	29,2	5,4	DC-2
16	31,9	0	DC-2
17	32,2	4,05	NTC
18	40,5	0	DC+2
19	40,5	2,7	DC+2
20	43,2	0	DC+2
21	43,2	2,7	DC+2
22	51,5	0	S15
23	51,5	3	G15
24	54,5	0	DC-3
25	54,5	2,7	DC-3
26	54,5	5,4	DC-3
27	57,2	0	DC-3
28	65,8	0	DC+3
29	65,8	2,7	DC+3
30	68,5	0	DC+3
31	68,5	2,7	DC+3
32	64,7	36	G16
33	61,7	36	S16
34	58,7	36	PH3
35	56	36	PH3
36	53,3	36	PH3
37	50,6	36	PH3
38	39,4	36	G14
39	36,4	36	S14
40	33,4	36	PH2
41	30,7	36	PH2
42	28	36	PH2
43	25,3	36	PH2
44	14,1	36	G12
45	11,1	36	S12
46	8,1	36	PH1
47	5,4	36	PH1
48	2,7	36	PH1
49	0	36	PH1



Pinout



Identification					
ID	**Component**	**Voltage**	**Current**	**Function**	**Comment**
T11 , T12 , T13 , T14 , T15 , T16	IGBT	1200 V	50 A	Inverter Switch	
D11 , D12 , D13 , D14 , D15 , D16	FWD	1200 V	50 A	Inverter Diode	
NTC	Thermistor			Thermistor	

Packaging instruction					
Standard packaging quantity (SPQ)	36	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for *flow* 2 packages see vincotech.com website.

Package data
Package data for *flow* 2 packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.

Document No.:	Date:	Modification:	Pages
30-x2126PA050SC-L287F09x-D3-14	31 May. 2017	New package quantity	All
30-x2126PA050SC-L287F09x-D4-14	02 Sep. 2020	Frame modification	1, 15